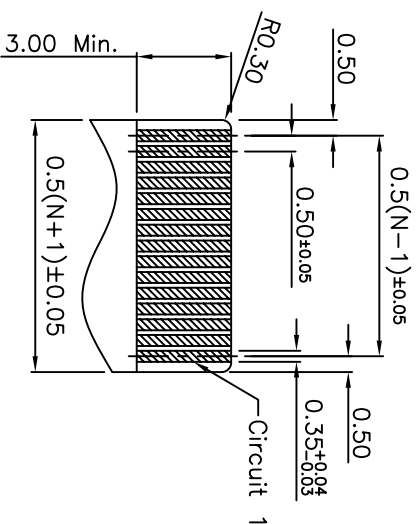
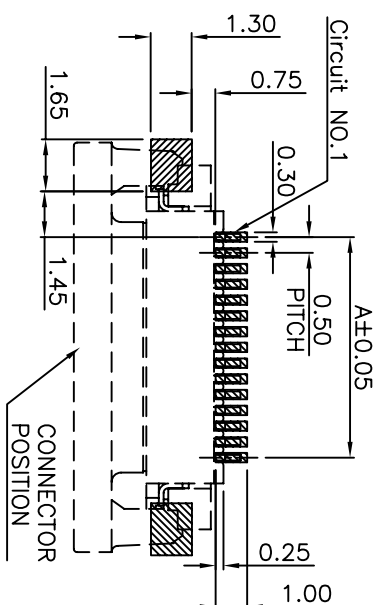
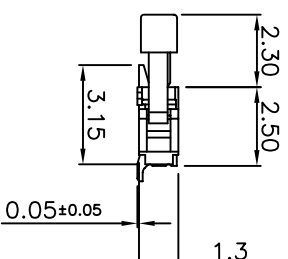
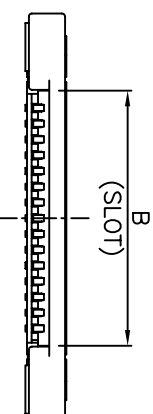
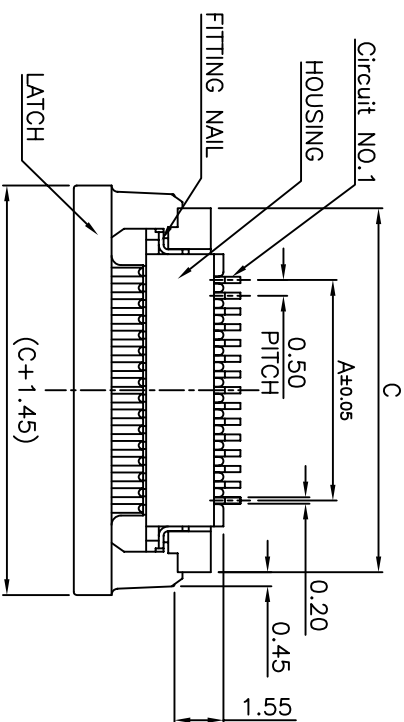




RECOMMENDED APPLICABLE FPC LAYOUT
(THICKNESS:0.3±0.03)



PCB PATTERN LAYOUT



CKT	Dim A	Dim B	Dim C
4	1.50	2.60	6.05
5	2.00	3.10	6.55
6	2.50	3.60	7.05
7	3.00	4.10	7.55
8	3.50	4.60	8.05
9	4.00	5.10	8.55
10	4.50	5.60	9.05
11	5.00	6.10	9.55
12	5.50	6.60	10.05
13	6.00	7.10	10.55
14	6.50	7.60	11.05
15	7.00	8.10	11.55
16	7.50	8.60	12.05
17	8.00	9.10	12.55
18	8.50	9.60	13.05
19	9.00	10.10	13.55
20	9.50	10.60	14.05
21	10.00	11.10	14.55
22	10.50	11.60	15.05
23	11.00	12.10	15.55
24	11.50	12.60	16.05
25	12.00	13.10	16.55
26	12.50	13.60	17.05
27	13.00	14.10	17.55
28	13.50	14.60	18.05
29	14.00	15.10	18.55
30	14.50	15.60	19.05

0	For APP70133新圖制	08/09/25	huomin
REV	REVISION DESCRIPTION	DATE	SIGNATURE

一般公差 TOLERANCES X ±0.5 XX ±0.15 XXX ±0.10 ANGLES ±2°	宏致電子股份有限公司 Aces Electronic Co.,Ltd.	製圖 (DRA) 0.5mm ZIF FPC CONN. 審核 (CHKD) 08/09/25 WGCH	核准 (APPD) Jason
檢驗尺寸標示 SYMBOLS ① INDICATE CLASSIFICATION DIMENSION SMT R/A B/C TYPE ② MARK IS CRITICAL DIM.	圖號 (DRAWING NO) 50530-XXXXX-XXX	比例 (SCALE) 4:1	張數 (SHEET) 1 OF 1
表面處理 (FINISH)	單位 (UNITS) mm	圖例	SIZE A4

- NOTES:
- MATERIAL:
 - HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0;
 - CONTACT: COPPER ALLOY
 - FITTING NAIL: COPPER ALLOY
 - LATCH: THERMOPLASTIC, HIGH TEMP., UL94V-0;
 - FINISH:
 - CONTACT:
 - 50u" MIN. NICKEL UNDERPLATING OVERALL.
 - N:120u" MIN. MATTE TIN PLATING OVER ALL
 - GOLD FLASH PLATING OVER ALL
 - FITTING NAIL:
 - 50u" MIN. NICKEL UNDERPLATING OVERALL.
 - N:120u" MIN. MATTE TIN PLATING OVER ALL
 - GOLD FLASH PLATING OVER ALL
 - REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.
 - SPEC. PLS. REFER TO PS-50525-XXXX-XXX
 - PACKAGE PLS. REFER TO 88296-XXXX-TRP
 - PART NUMBER
- 50530-XXX X X-XXX
- NO OF CKT
- PACKING
- O:REEL
- 1:TUBE
- PLATING
- 1: GOLD FLASH OVERALL
- N: MATTE TIN (LEAD FREE)
- | | | |
|-----|----------------|-----------------|
| XXX | Housing Color. | Actuator Color. |
| 001 | BLACK | WHITE |